

PATENT ASSIGNMENT

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Ji-Yun KWON	07/11/2013
Jin-Hee KANG	07/11/2013
Dae-Yun KIM	07/11/2013
Sang-Kyeon KIM	07/11/2013
Sang-Soo KIM	07/11/2013
Yong-Tae KIM	07/11/2013
Kun-Bae NOH	07/11/2013
Eun-Bi PARK	07/11/2013
Jae-Hwan SONG	07/11/2013
Eun-Kyoung YOUN	07/11/2013
Jong-Hwa LEE	07/11/2013
Jin-Young LEE	07/11/2013
Chung-Beum HONG	07/11/2013
Eun-Ha HWANG	07/11/2013
In-Chul HWANG	07/11/2013

RECEIVING PARTY DATA

Name:	Cheil Industries Inc.
Street Address:	290 Gongdan-dong
Internal Address:	Gumi-si, Gyeongsangbuk-do
City:	Gumi-si
State/Country:	KOREA, REPUBLIC OF
Postal Code:	730-710

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13962153

CORRESPONDENCE DATA

Fax Number: 7049456735  
*Correspondence will be sent via US Mail when the fax attempt is unsuccessful.*  
Phone: 704-945-6700  
Email: docket@summalaw.com  
Correspondent Name: Melissa B. Pendleton  
Address Line 1: 11610 N. Community House Road  
Address Line 2: Suite 200  
Address Line 4: Charlotte, NORTH CAROLINA 28277

ATTORNEY DOCKET NUMBER:	7020.146
NAME OF SUBMITTER:	Melissa B. Pendleton
Signature:	/Melissa B. Pendleton/
Date:	08/08/2013

Total Attachments: 6  
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### RECORDATION FORM COVER SHEET PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

**1. Name of conveying party(ies)**  
 1) Ji-Yun KWON      7) Kun-Bae MOH      13) Chung-Beum HONG  
 2) Jin-Hee KANG    8) Eun-Bi PARK      14) Eun-Ha HWANG  
 3) Dae-Yun KIM     9) Jae-Hwan SONG    15) In-Chul HWANG  
 4) Sang-Kyeon KIM   10) Eun-Kyoung YOUN  
 5) Sang-Soo KIM     11) Jong-Hwa LEE  
 6) Yong-Tae KIM     12) Jin-Young LEE

Additional name(s) of conveying party(ies) attached?  Yes  No

**2. Name and address of receiving party(ies)**  
 Name: Cheil Industries Inc.  
 Internal Address: \_\_\_\_\_  
 Street Address: 290 Gongdan-dong  
 City: Gumi-si  
 State: Gyeongsangbuk-do  
 Country: South Korea Zip: 730-710  
 Additional name(s) & address(es) attached?  Yes  No

**3. Nature of conveyance/Execution Date(s):**  
 Execution Date(s) July 11, 2013

Assignment       Merger  
 Security Agreement     Change of Name  
 Joint Research Agreement  
 Government Interest Assignment  
 Executive Order 9424, Confirmatory License  
 Other \_\_\_\_\_

**4. Application or patent number(s):**  This document is being filed together with a new application.  
 A. Patent Application No.(s)  
13/962,153  
 B. Patent No.(s)  
 \_\_\_\_\_  
 Additional numbers attached?  Yes  No

**6. Total number of applications and patents involved:** 1

**7. Total fee (37 CFR 1.21(h) & 3.41) \$** 40.00  
 Authorized to be charged by credit card  
 Authorized to be charged to deposit account  
 Enclosed  
 None required (government interest not affecting title)

**5. Name and address to whom correspondence concerning document should be mailed:**  
 Name: Summa, Additon & Ashe, P.A.  
 Internal Address: \_\_\_\_\_  
 Street Address: 11610 N. Community House Road, Suite 200  
 City: Charlotte  
 State: NC Zip: 28277-2199  
 Phone Number: 704-945-6700  
 Fax Number: 704-945-6735  
 Email Address: \_\_\_\_\_

**8. Payment Information**  
 a. Credit Card Last 4 Numbers \_\_\_\_\_  
 Expiration Date \_\_\_\_\_  
 b. Deposit Account Number \_\_\_\_\_  
 Authorized User Name \_\_\_\_\_

**9. Signature:** /Melissa B. Pendleton/ August 8, 2013  
 \_\_\_\_\_  
 Signature Date  
Melissa B. Pendleton  
 Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: 6

## ASSIGNMENT

WHEREAS, I, **Ji-Yun KWON**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Jin-Hee KANG**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Dae-Yun KIM**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Sang-Kyeon KIM**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Sang-Soo KIM**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Yong-Tae KIM**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Kun-Bae NOH**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Eun-Bi PARK**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Jae-Hwan SONG**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Eun-Kyoung YOUNG**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Jong-Hwa LEE**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Jin-Young LEE**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Chung-Beum HONG**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea;

Eun-Ha HWANG, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; and In-Chul HWANG, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea (hereinafter referred to as "ASSIGNOR"), am a joint inventor of certain new and useful improvements (hereinafter collectively referred to as "INVENTION") in *Photosensitive Resin Composition for Insulating Film of Display Device, Insulating Film Using the Same, and Display Device Using the Same*, for which an application for United States Letters Patent is being filed concurrently herewith and which application claims priority from a Korean application filed on December 28, 2012, under Serial No. 10-2012-0157564, all applications listed above being hereinafter referred to as the "APPLICATION"; and

WHEREAS, Cheil Industries Inc., a Korean corporation (hereinafter referred to as "ASSIGNEE"), having a principal place of business at 290 Gongdan-dong, Gumi-si, Gyeongsangbuk-do 730-030, Republic of Korea, has acquired the equitable right, title, and interest—and is desirous of acquiring any remaining right, title, and interest—in and to said INVENTION as described in said APPLICATION, and in and to any and all Letters Patent that shall be granted with respect to said INVENTION in the United States of America and all foreign countries;

NOW, THEREFORE, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, have sold, assigned, transferred, and conveyed unto said ASSIGNEE, its successors and assigns, my equitable right, title, and interest—and by these presents do hereby sell, assign, transfer, and convey unto said ASSIGNEE, its successors and assigns any remaining right, title, and interest—in and to said INVENTION and APPLICATION, in and to any and all

continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues, reexaminations, or extensions thereof that may be granted therefore or thereon, for the full term for which said Letters Patent may be granted, together with the right to claim the priority of said APPLICATION in all foreign countries in accordance with international treaties and conventions, the same to be held and enjoyed by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if an assignment and sale had not been made.

I acknowledge that at the time the INVENTION was made, the INVENTION was subject to an obligation of assignment to said ASSIGNEE. I further acknowledge that said ASSIGNEE has the sole right to determine patent prosecution strategies with respect to said INVENTION and all corresponding applications, and hereby request that Letters Patent be issued in accordance with this assignment.

I further covenant and agree to bind my heirs, legal representatives, and assigns, promptly to communicate to said ASSIGNEE or its representatives any facts known to me relating to said INVENTION, to testify in any interference or legal proceedings involving said INVENTION, to execute any additional papers that may be requested to confirm the right of the ASSIGNEE, its representatives, successors or assigns to secure patent or similar protection for said INVENTION in all countries and to vest in the ASSIGNEE complete title to said INVENTION and Letters Patent, without further compensation, but at the expense of said ASSIGNEE, its successors, assigns and other legal representatives.

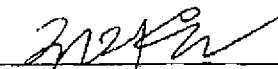
As the below named inventor, I hereby declare:

The application for United States Letters Patent being filed concurrently herewith was made or authorized to be made by me.

I believe that I am the original or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in the declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

IN WITNESS WHEREOF, I have hereunto signed my name on the day and year set forth below.

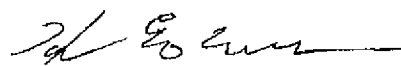
July 11, 2013   
Ji-Yun KWON

July 11, 2013 강진희  
Jin-Hee KANG

July 11, 2013 김대영  
Dae-Yun KIM

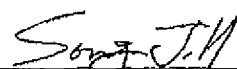
July 11, 2013 김상권  
Sang-Kyeon KIM


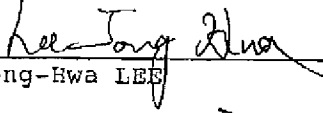
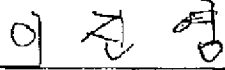
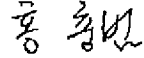
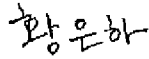
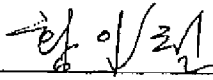
July 11, 2013 김상수  
Sang-Soo KIM

July 11, 2013   
Yong-Tae KIM

July 11, 2013 노건배  
Kun-Bae NOH

July 11, 2013 박은비  
Eun-Bi PARK

July 11, 2013   
Jae-Hwan SONG

_____ July 11, 2013	 _____ Eun-Kyoung YOUN
_____ July 11, 2013	 _____ Jong-Hwa LEE
_____ July 11, 2013	 _____ Jin-Young LEE
_____ July 11, 2013	 _____ Chung-Beum HONG
_____ July 11, 2013	 _____ Eun-Ha HWANG
_____ July 11, 2013	 _____ In-Chul HWANG